Triacs

## GENERAL DESCRIPTION

Glass passivated, sensitive gate triacs in a full pack plastic envelope, intended for use in general purpose bidirectional switching and phase control applications, where high sensitivity is required in all four quadrants.

PINNING - SOT186

| PIN | DESCRIPTION |
| :---: | :--- |
| 1 | main terminal 1 |
| 2 | main terminal 2 |
| 3 | gate |
| case | isolated |

## QUICK REFERENCE DATA

| SYMBOL | PARAMETER | MAX. | MAX. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | BT138F- | 500E | 600E | 800E |  |
| $V_{\text {DRM }}$ | Repetitive peak off-state voltages | 500 | 600 | 800 | V |
| $\mathrm{I}_{\text {T(RMS) }}$ | RMS on-state current | 12 | 12 | 12 | A |
| $\mathrm{I}_{\text {TSM }}$ | Non-repetitive peak on-state current | 90 | 90 | 90 | A |

PIN CONFIGURATION


SYMBOL


## LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. |  | MAX. |  | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DRM }}$ | Repetitive peak off-state voltages |  | - | $\begin{aligned} & -500 \\ & 500^{1} \end{aligned}$ | $\begin{aligned} & \hline-600 \\ & 600^{1} \end{aligned}$ | $\begin{aligned} & \hline-800 \\ & 800 \end{aligned}$ | V |
| $\begin{aligned} & \mathrm{I}_{\text {TRMS) }} \\ & \mathrm{I}_{\text {TSM }} \end{aligned}$ | RMS on-state current Non-repetitive peak on-state current | full sine wave; $T_{\text {hs }} \leq 56^{\circ} \mathrm{C}$ <br> full sine wave; $\mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$ prior <br> to surge; with reapplied $\mathrm{V}_{\text {DRM(max) }}$ <br> $\mathrm{t}=20 \mathrm{~ms}$ <br> $\mathrm{t}=16.7 \mathrm{~ms}$ <br> $\mathrm{t}=10 \mathrm{~ms}$ <br> $\mathrm{I}_{\mathrm{TM}}=20 \mathrm{~A} ; \mathrm{I}_{\mathrm{G}}=0.2 \mathrm{~A}$; <br> $\mathrm{dl}_{\mathrm{G}} / \mathrm{dt}=0.2 \mathrm{~A} / \mu \mathrm{s}$ | - | 12 |  |  | A |
| $I^{2} t$ $\mathrm{dl}_{\mathrm{T}} / \mathrm{dt}$ | $1^{2}$ t for fusing Repetitive rate of rise of on-state current after triggering |  | - | $\begin{gathered} 90 \\ 100 \end{gathered}$ |  |  | A |
|  |  |  | - | 40 |  |  | $\mathrm{A}^{2} \mathrm{~s}$ |
|  |  | $\begin{aligned} & \text { T2+ G+ } \\ & \text { T2+ G- } \\ & \text { T2- G- } \\ & \text { T2- G+ } \end{aligned}$ | - |  | 50 50 50 10 |  | A/ $/ \mathrm{s}$ A/us A/us A/us |
| $\mathrm{I}_{\text {GM }}$ | Peak gate current | over any 20 ms period |  |  | 2 |  | A |
| $\mathrm{V}_{\text {GM }}$ | Peak gate voltage |  |  |  | 5 |  | V |
| $\mathrm{P}_{\mathrm{pam}}$ | Peak gate power |  | - |  | 5 |  | W |
| $\mathrm{P}_{\mathrm{G} \text { (AV) }}$ | Average gate power |  |  |  | 0.5 |  |  |
| $\mathrm{T}_{\mathrm{T} \text { stg }}^{\mathrm{s} \text { (ta }}$ | Storage temperature |  | -40 |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\mathrm{j}}$ | Operating junction temperature |  |  |  | 125 |  | ${ }^{\circ} \mathrm{C}$ |

[^0]
## ISOLATION LIMITING VALUE \& CHARACTERISTIC

$\mathrm{T}_{\text {hs }}=25^{\circ} \mathrm{C}$ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| V $_{\text {isol }}$ | Repetitive peak voltage from all <br> three terminals to external <br> heatsink | R.H. $\leq 65 \%$; clean and dustfree | - |  | 1500 | V |
| $\mathrm{C}_{\text {isol }}$ | Capacitance from T2 to external <br> heatsink | $\mathrm{f}=1 \mathrm{MHz}$ | - | 12 | - | pF |

THERMAL RESISTANCES

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| :--- | :--- | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{R}_{\mathrm{th} j \text {-hs }}$ | Thermal resistance <br> junction to heatsink | full or half cycle <br> with heatsink compound <br> $\mathrm{R}_{\mathrm{th} j-\mathrm{a}}$ | Thermal resistance <br> junction to ambient | in free air |  |  |
|  | - | - | 4.0 | $\mathrm{~K} / \mathrm{W}$ |  |  |

## STATIC CHARACTERISTICS

$\mathrm{T}_{\mathrm{i}}=25^{\circ} \mathrm{C}$ unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{I}_{\text {GT }}$ | Gate trigger current | $\begin{array}{ll}\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V} ; \mathrm{I}_{\mathrm{T}}=0.1 \mathrm{~A} & \\ & \mathrm{~T} 2+\mathrm{G}+ \\ & \mathrm{T} 2+\mathrm{G}- \\ & \text { T2- }- \\ & \text { T2-G+ }\end{array}$ |  |  |  |  |
|  |  |  | - | 2.5 4.0 | 10 10 | $\mathrm{mA}_{\mathrm{mA}}$ |
|  |  |  | - | 5.0 | 10 | mA |
|  |  |  | - | 11 | 25 | mA |
| $\mathrm{I}_{\mathrm{L}}$ | Latching current |  |  |  |  |  |
|  |  |  |  | 3.2 16 | 30 40 | mA |
|  |  |  | - | 4.0 | 30 | mA |
|  |  |  |  | 5.5 | 40 | mA |
|  |  | $\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V} ; \mathrm{I}_{\mathrm{GT}}=0.1 \mathrm{~A}$ | - | 4.0 |  |  |
| $V_{T}$ | On-state voltage | $l_{T}=15 \mathrm{~A}$ |  | 1.4 | 1.65 | V |
| $V_{G T}$ | Gate trigger voltage | $\mathrm{V}_{\mathrm{D}}=12 \mathrm{~V} ; \mathrm{I}_{\mathrm{T}}=0.1 \mathrm{~A}$ | 2 | 0.7 | 1.5 | V |
|  |  | $\mathrm{V}_{\mathrm{D}}=400 \mathrm{~V} ; \mathrm{I}_{T}=0.1 \mathrm{~A} ; \mathrm{T}_{\mathrm{T}}=12{ }^{\circ} \mathrm{C}$ | 0.25 | 0.4 |  | V |
| $\mathrm{I}_{\mathrm{D}}$ | Off-state leakage current | $\mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\text {DRM (max) }} ; \mathrm{T}_{\mathrm{j}}=125{ }^{\circ} \mathrm{C}$ |  | 0.1 | 0.5 | mA |

## DYNAMIC CHARACTERISTICS

$\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$ unless otherwise stated

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{aligned} & \hline \mathrm{dV}_{\mathrm{D}} / \mathrm{dt} \\ & \mathrm{t}_{\mathrm{gt}} \end{aligned}$ | Critical rate of rise of off-state voltage Gate controlled turn-on time | $\mathrm{V}_{\mathrm{DM}}=67 \% \mathrm{~V}_{\text {DRM (max }} ; \mathrm{T}_{\mathrm{j}}=125^{\circ} \mathrm{C}$; exponential waveform; gate open circuit $I_{T M}=16 \mathrm{~A} ; \mathrm{V}_{\mathrm{D}}=\mathrm{V}_{\text {DRM(max) }} ; \mathrm{I}_{\mathrm{G}}=0.1 \mathrm{~A}$; $\mathrm{dl}_{\mathrm{G}} / \mathrm{dt}=5 \mathrm{~A} / \mu \mathrm{s}$ | - | 50 2 | - | $\mathrm{V} / \mu \mathrm{s}$ $\mu \mathrm{s}$ |



Fig.1. Maximum on-state dissipation, $P_{\text {tot }}$, versus rms on-state current, $I_{T(\text { RMS })}$, where $\alpha=$ conduction angle.


Fig.2. Maximum permissible non-repetitive peak on-state current $I_{\text {TSM }}$, versus pulse width $t_{p}$, for sinusoidal currents, $t_{p} \leq 20 \mathrm{~ms}$.


Fig.3. Maximum permissible non-repetitive peak on-state current $l_{\text {TSM }}$, versus number of cycles, for sinusoidal currents, $f=50 \mathrm{~Hz}$.


Fig.4. Maximum permissible rms current $I_{T(R M S)}$, versus heatsink temperature $T_{h s}$


Fig.5. Maximum permissible repetitive rms on-state current $I_{T(R M S)}$, versus surge duration, for sinusoidal currents, $f=50 \mathrm{~Hz} ; T_{h s} \leq 56^{\circ} \mathrm{C}$.


Fig.6. Normalised gate trigger voltage $V_{G T}\left(T_{j}\right) / V_{G T}\left(25^{\circ} \mathrm{C}\right)$, versus junction temperature $T_{j}$.


Fig.7. Normalised gate trigger current $I_{G T}\left(T_{j}\right) / I_{G T}\left(25^{\circ} \mathrm{C}\right)$, versus junction temperature $T_{j}$.


Fig.8. Normalised latching current $I_{L}\left(T_{T}\right) / I_{L}\left(25^{\circ} \mathrm{C}\right)$, versus junction temperature $T_{\text {. }}$.


Fig.9. Normalised holding current $I_{H}\left(T_{j}\right) / I_{H}\left(25^{\circ} \mathrm{C}\right)$, versus junction temperature $T_{j}$.


Fig.10. Typical and maximum on-state characteristic.


Fig.11. Transient thermal impedance $Z_{t h j-h s}$, versus pulse width $t_{p}$.


Fig.12. Typical, critical rate of rise of off-state voltage, $d V_{D} / d t$ versus junction temperature $T_{j}$.

## Triacs

BT138F series E
sensitive gate

## MECHANICAL DATA

Dimensions in mm
Net Mass: 2 g


Fig.13. SOT186; The seating plane is electrically isolated from all terminals.

## Notes

1. Accessories supplied on request: refer to mounting instructions for F-pack envelopes.
2. Epoxy meets UL94 V0 at 1/8".

Triacs
sensitive gate

## DEFINITIONS

| Data sheet status |  |
| :--- | :--- |
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values |  |
| Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one <br> or more of the limiting values may cause permanent damage to the device. These are stress ratings only and <br> operation of the device at these or at any other conditions above those given in the Characteristics sections of <br> this specification is not implied. Exposure to limiting values for extended periods may affect device reliability. |  |
| Application information |  |
| Where application information is given, it is advisory and does not form part of the specification. |  |
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## LIFE SUPPORT APPLICATIONS

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[^0]:    1 Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed $15 \mathrm{~A} / \mathrm{hs}$.

